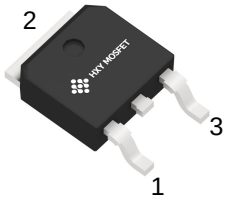
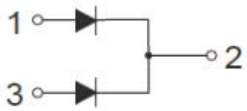
Features

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any



TO-252-2L



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
RB088BM200FHTL	TO-252-2L	MBRD10200CT	2500

Maximum Ratings Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified

Characteristics	Symbol	Limit	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	200	V
Maximum RMS voltage	V_{RMS}	140	V
Maximum DC Blocking Voltage	V_{DC}	200	V
Maximum Average Forward Rectified Current Per diode Per device	$I_{F(AV)}$	5 10	A
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method) Per leg	I_{FSM}	100	A
Max Instantaneous Forward Voltage at 5.0 A Per leg	V_F	0.92	V
Maximum DC Reverse Current Ta= 25°C at Rated DC Reverse Voltage Ta=125°C	I_R	0.05 20	mA
Typical Junction Capacitance [1]	C_j	400	pF
Typical Thermal Resistance [2]	$R_{\theta JA}$	35	°C/W
Operating Junction Temperature Range	T_j	-55 ~ +175	°C
Storage Temperature Range	T_{stg}	-55 ~ +175	°C

(1)Measured at 1 MHz and applied reverse voltage of 4 V D.C
(2)P.C.B. mounted with 10cmX10cmX1mm copper pad areas.

Typical Characteristics

Fig.1 Typical Forward Current Derating Curve

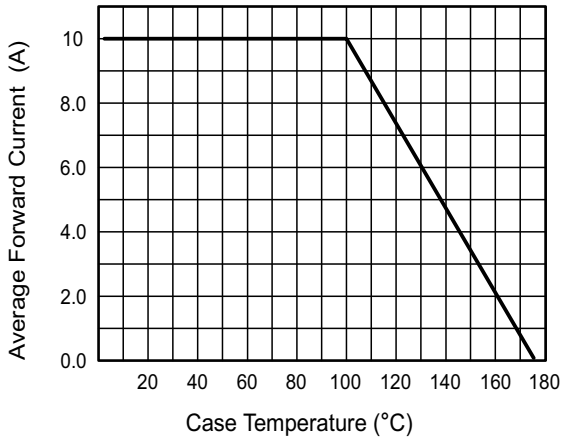


Fig.2 Typical Reverse Characteristics

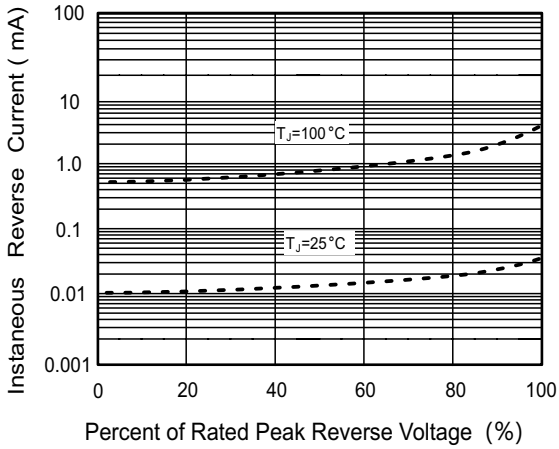


Fig.3 Typical Forward Characteristic

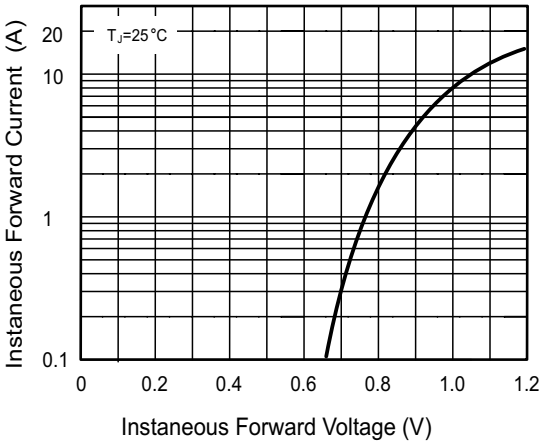


Fig.4 Typical Junction Capacitance

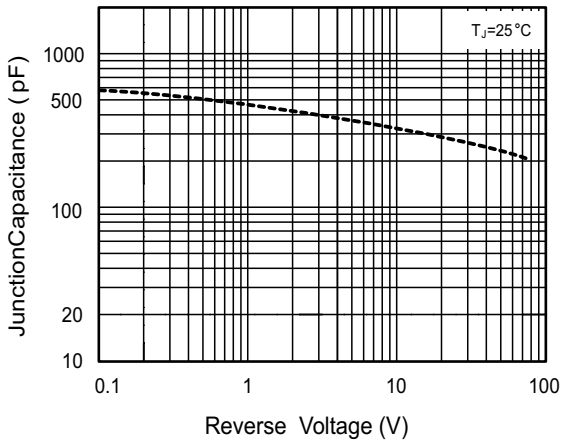


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

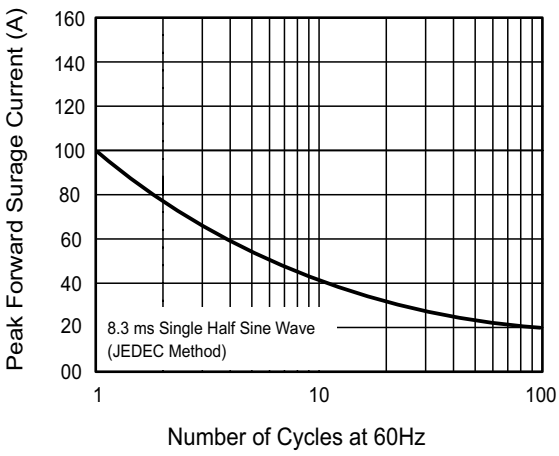
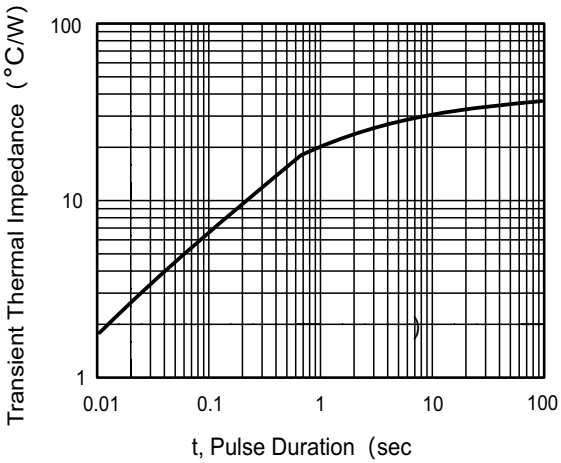
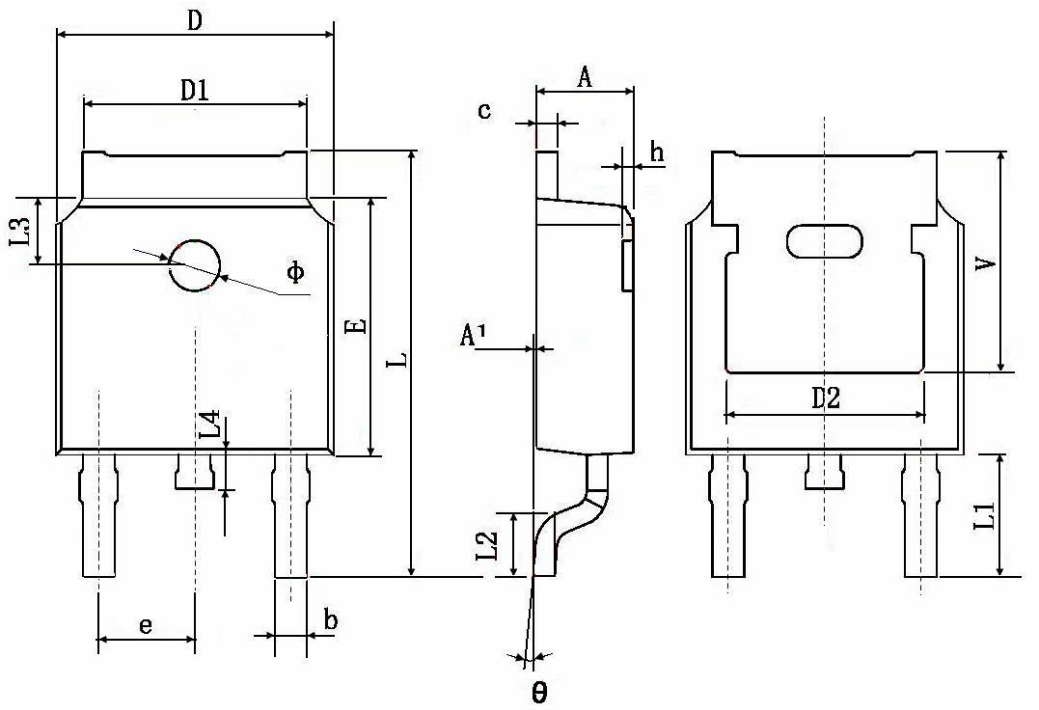


Fig.6- Typical Transient Thermal Impedance



TO-252-2L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	0.483 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012

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TPSMB100CA-VR HPTVSUC3D5VB PESDNC2XD5VBL PESDSC2FD5VU HRCLAMP3371ZCTFT
HSG3D15B3.3MA LM393DR-HXY PESDLC2FD3V3BH TPSMB28A-VR ESD5L5.0C-HXY HSTS521050B331
AQ15C-01FTG BV05C-H HACPDQC5V0-HF HLY323BC1524L RLSD32A121V 60N06 AZ4836-01L
HAZ4007-01H HCEZ36V,L3F HSEN2411D3 HSEN3611D3 PESDNC2XD5VBF PJSD24CW_R1